Electronic Patent Application Fee Transmittal								
Application Number:	10587725							
Filing Date:	26-Jul-2006							
Title of Invention:	METHOD FOR MANUFACTURING SOI WAFER							
First Named Inventor/Applicant Name:	Etsuro Morita							
Filer:	Anton E. Skaugset/Margaret Burton							
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Filed as Large Entity								
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Basic Filing:								
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